



(12) **United States Design Patent**  
**Lee et al.**

(10) **Patent No.:** **US D600,675 S**  
(45) **Date of Patent:** **\*\* Sep. 22, 2009**

(54) **PAIR OF IN EAR HEADPHONES**

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(73) Assignee: **Monster Cable Products, Inc.**, Brisbane, CA (US)

(\*\*) Term: **14 Years**

(21) Appl. No.: **29/322,531**

(22) Filed: **Aug. 6, 2008**

(51) **LOC (9) Cl.** ..... **14-01**

(52) **U.S. Cl.** ..... **D14/205**

(58) **Field of Classification Search** ..... D14/205,  
D14/206, 223, 142, 188, 192, 249; 181/129,  
181/130, 135, 137; 379/430, 431, 420.04;  
381/380, 381, 370, 373, 186, 322; 128/864,  
128/866, 867; D24/106

See application file for complete search history.

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(57) **CLAIM**

The ornamental design for a pair of in ear headphones, as shown and described.

**DESCRIPTION**

FIG. 1 is a perspective view of a pair of in ear headphones showing our new design;

FIG. 1A is a perspective view of a pair of in ear headphones as shown in FIG. 1, with the addition of an enlarged section depicting the intricacies of the new design.

FIG. 2 is a front view thereof;

FIG. 3 is a rear view thereof;

FIG. 4 is a side elevation view of a pair of in ear headphones with one in ear headphone shown separately for ease of illustration;

FIG. 5 is an opposite side elevational view of a pair of in ear headphones with one in ear headphone shown separately for ease of illustration;

FIG. 6 is a top view thereof;

FIG. 7 is a bottom view thereof.

FIG. 8 is a perspective view a second embodiment of a pair of in ear headphones showing our new design.

FIG. 9 is a front view thereof;

FIG. 10 is a rear view thereof;

FIG. 11 is a side elevational view of a pair of in ear headphones with one in ear headphone shown separately for ease of illustration;

FIG. 12 is an opposite side elevational view of a pair of in ear headphones with one in ear headphone shown separately for ease of illustration;

FIG. 13 is a top view thereof;

FIG. 14 is a bottom view thereof;

FIG. 15 is a perspective view of a third embodiment of a pair of in ear headphones showing our new design.

FIG. 16 is a front view thereof;

FIG. 17 is a rear view thereof;

FIG. 18 is a side elevational view of a pair of in ear headphones with one in ear headphone shown separately for ease of illustration;

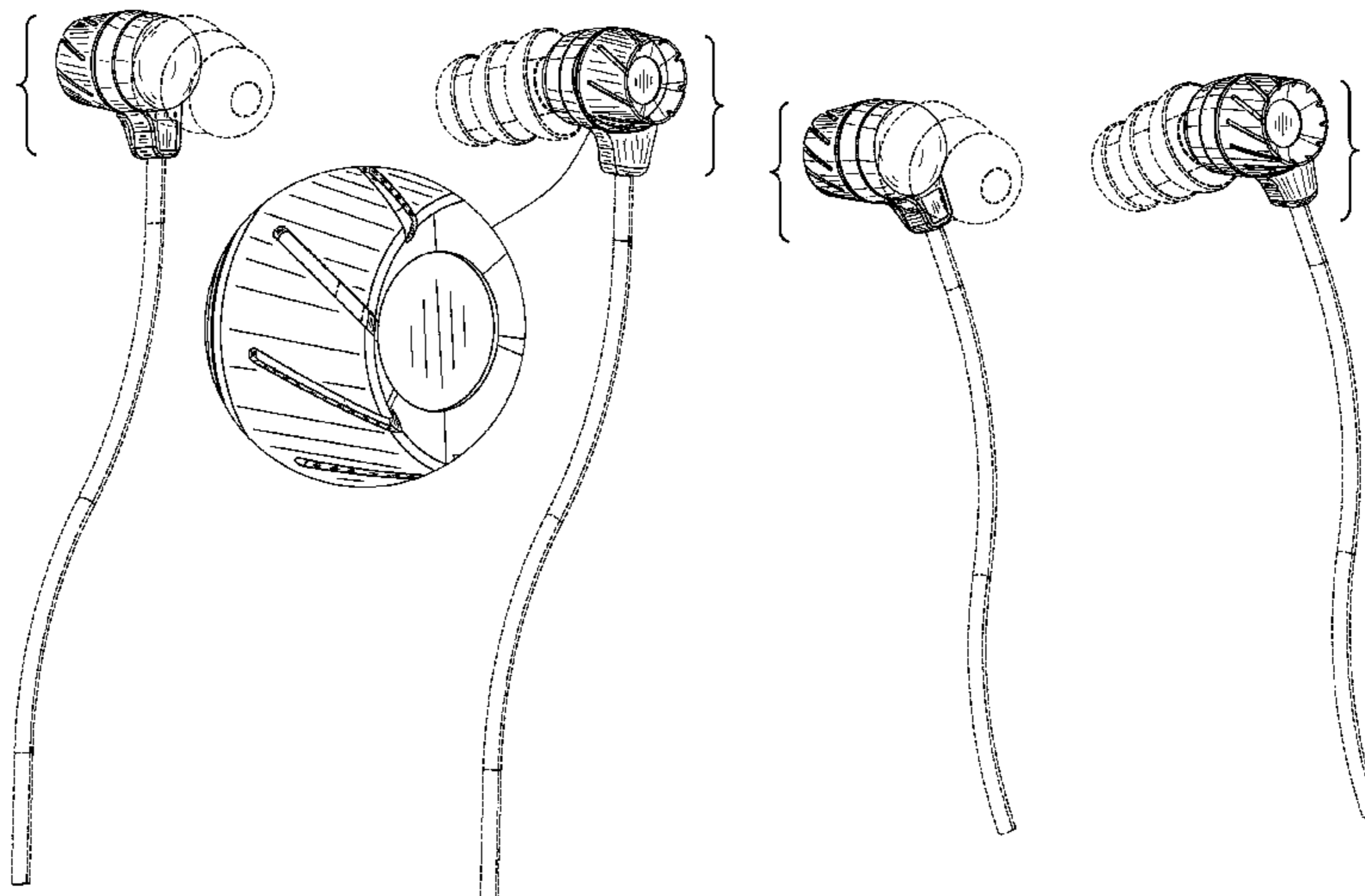
FIG. 19 is an opposite side elevational view of a pair of in ear headphones with one in ear headphone shown separately for ease of illustration;

FIG. 20 is a top view thereof; and,

FIG. 21 is a bottom view thereof.

The broken lines showing the environment in the Figures are for illustrative purposes only and form no part of the claimed design.

**1 Claim, 13 Drawing Sheets**



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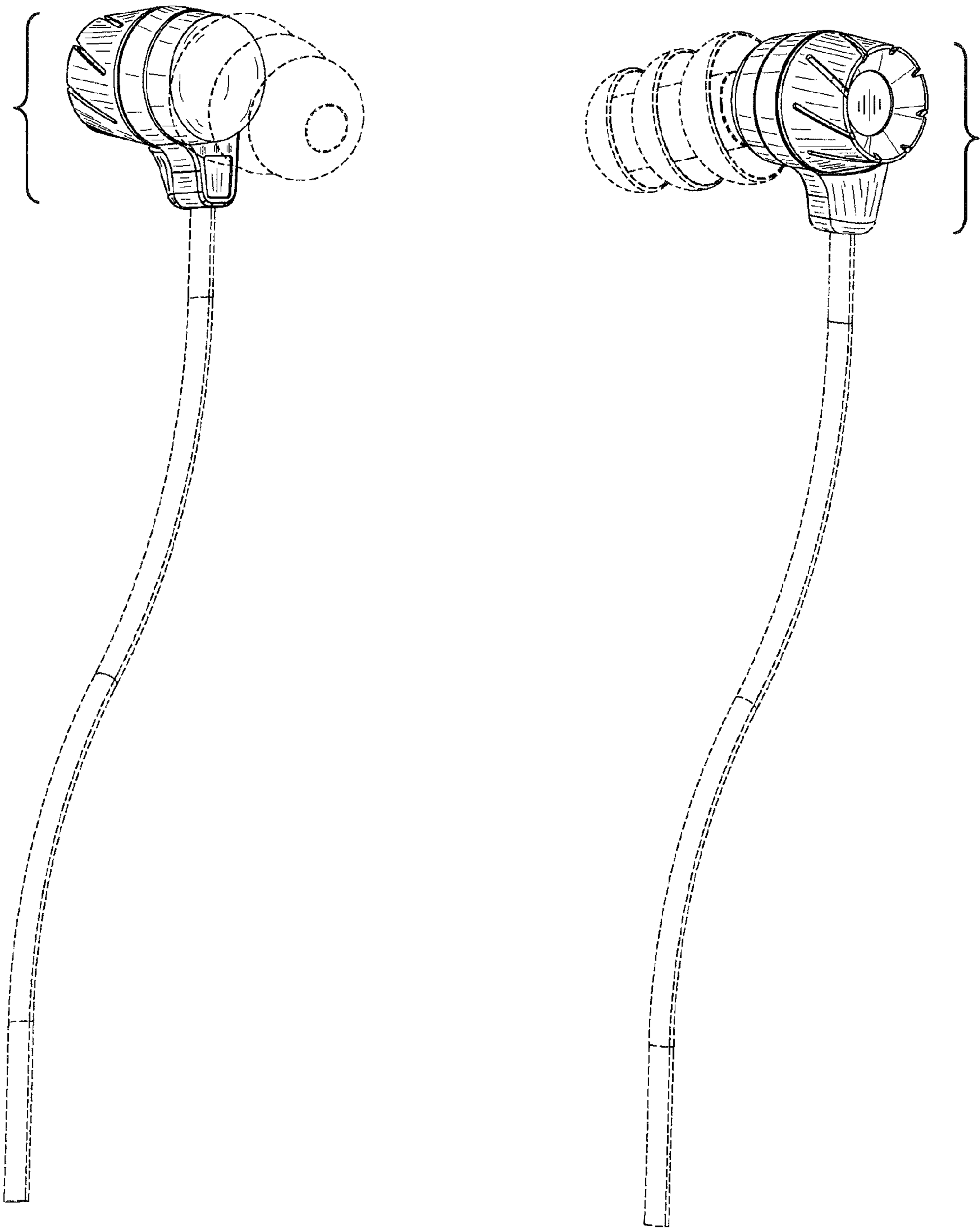


Figure 1

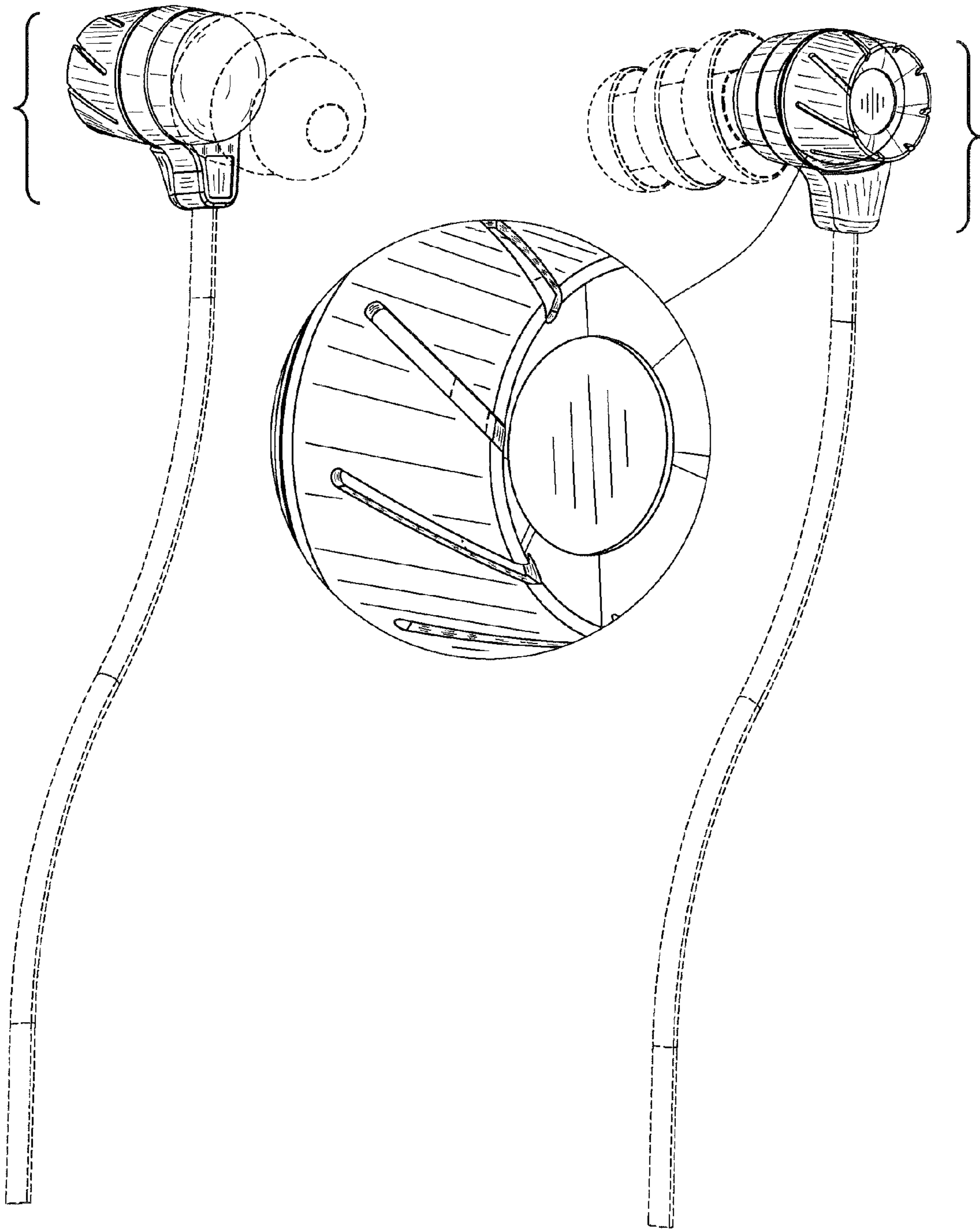


Figure 1A

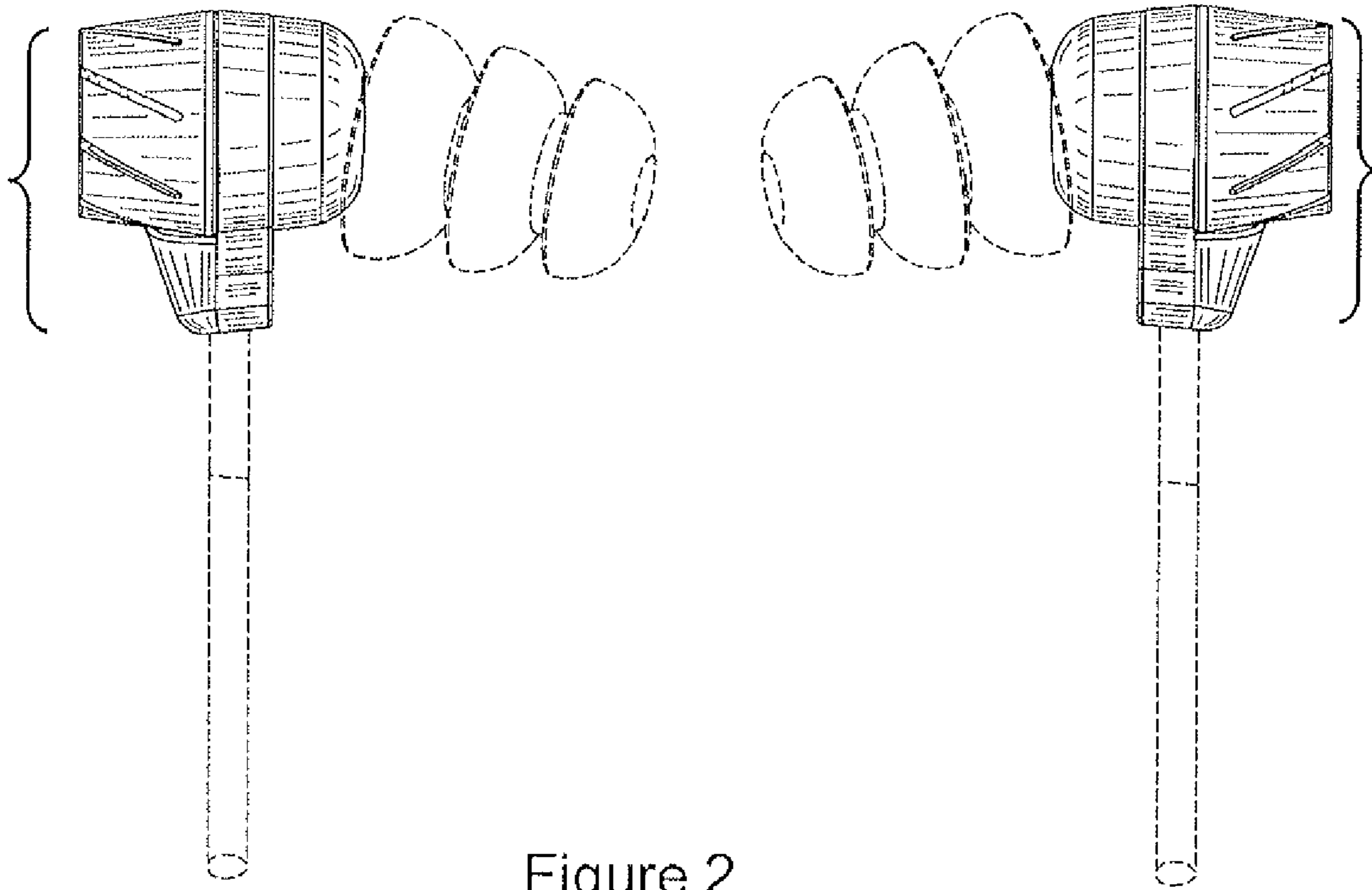


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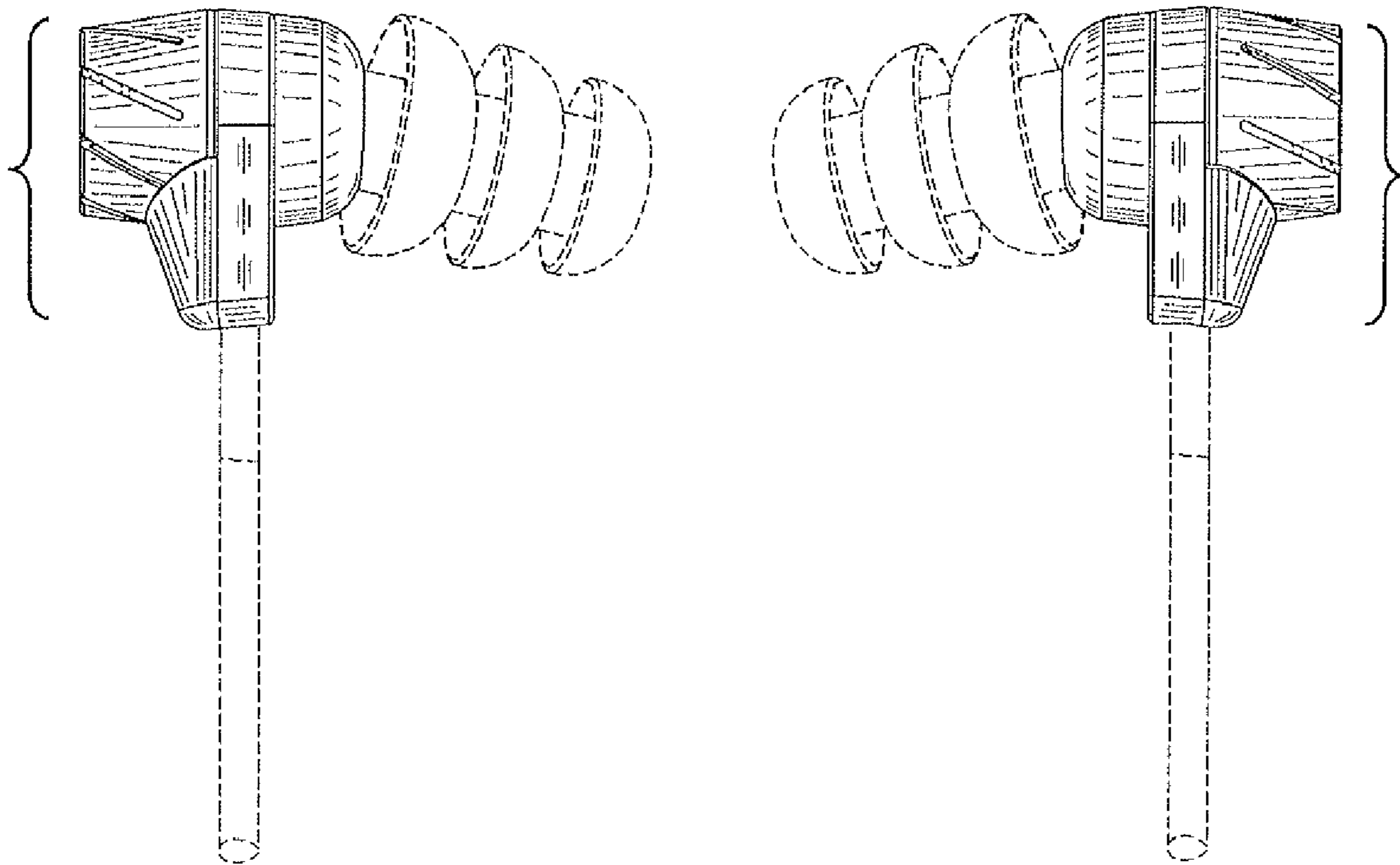


Figure 3

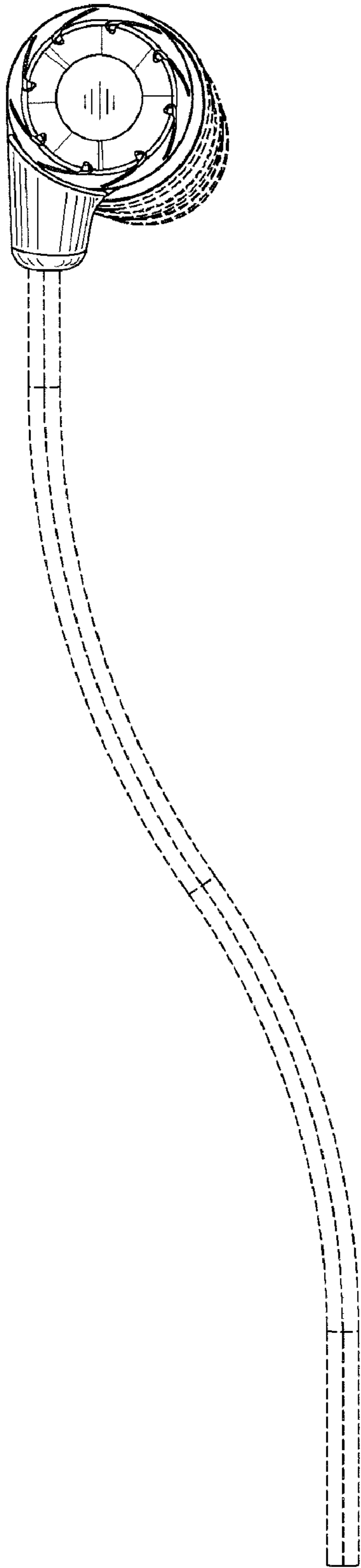


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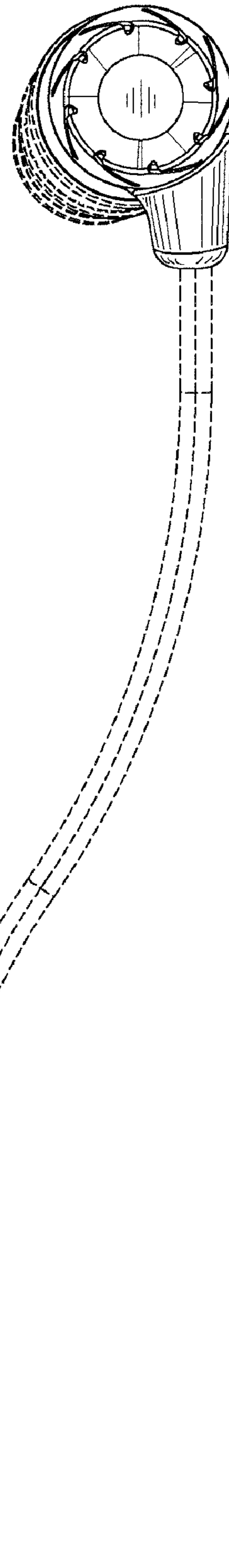


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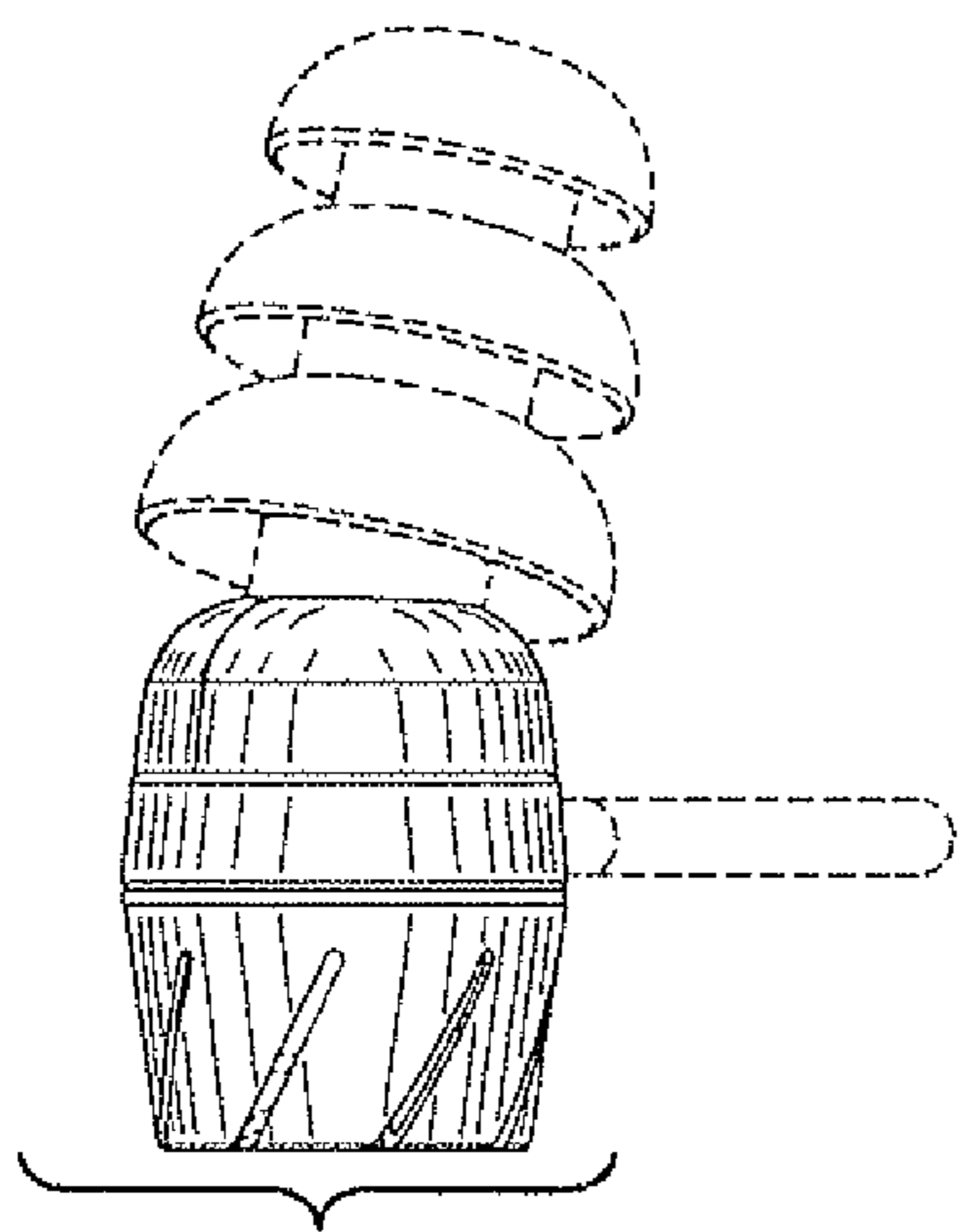
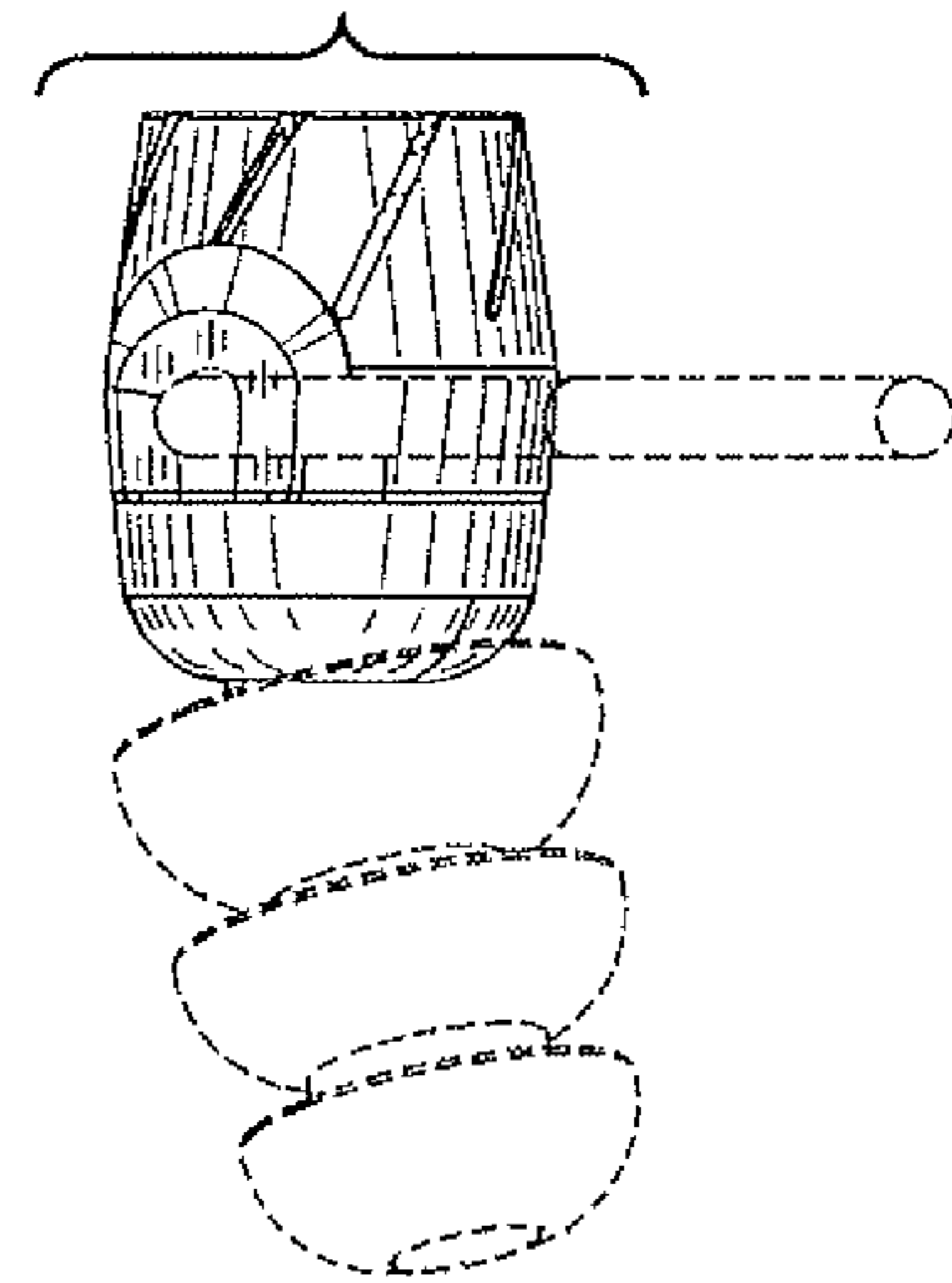
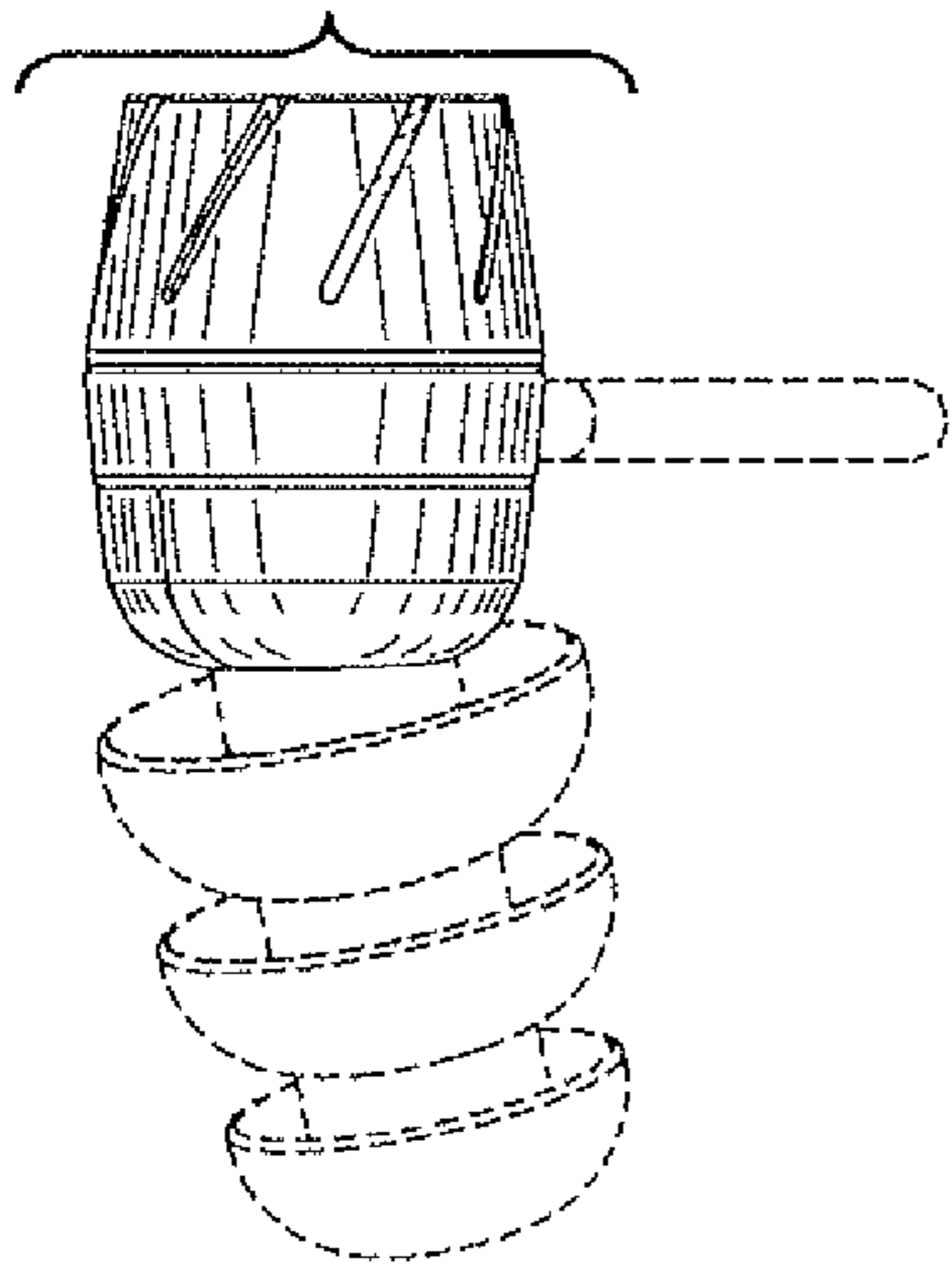


Figure 6

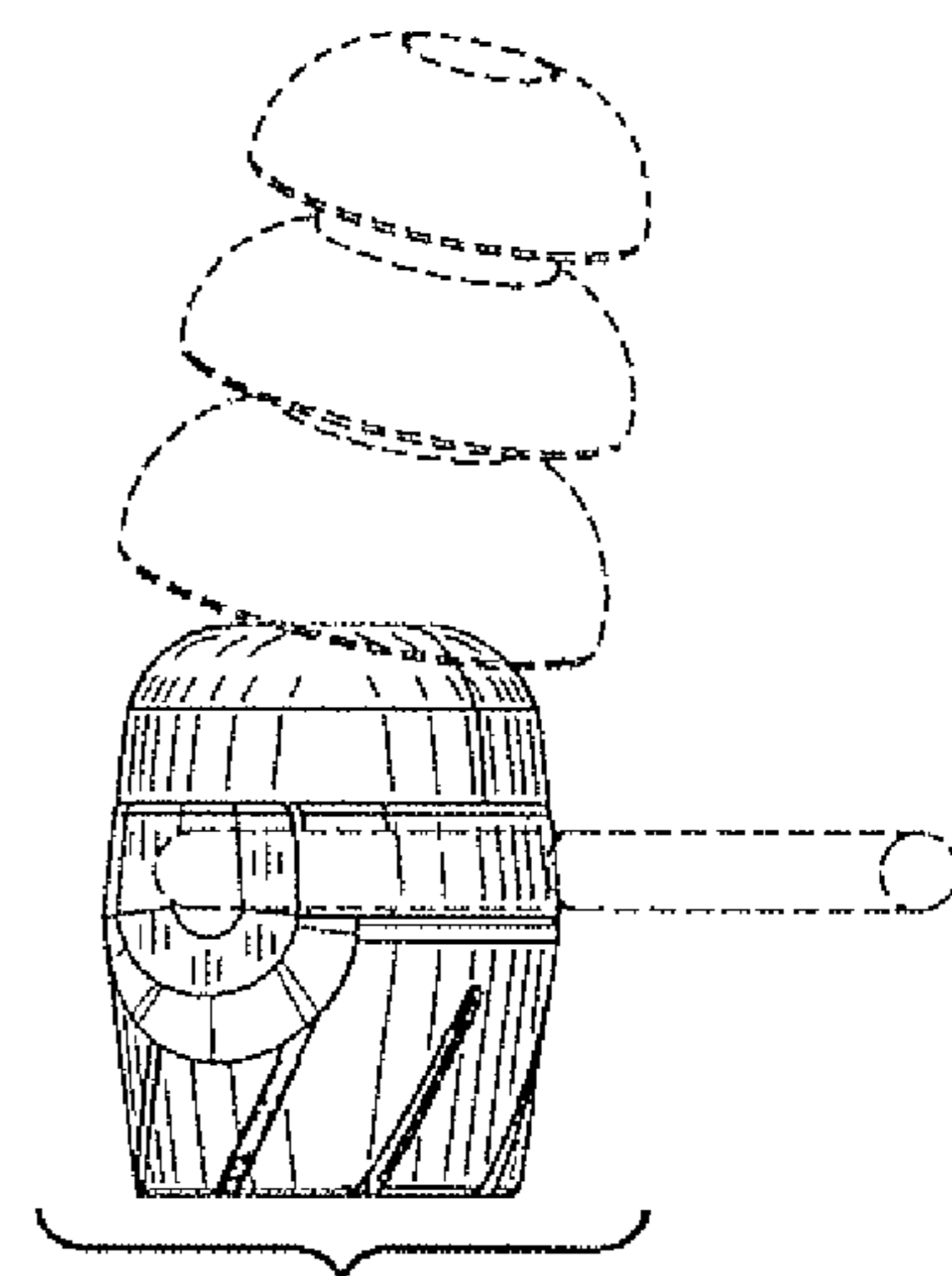


Figure 7

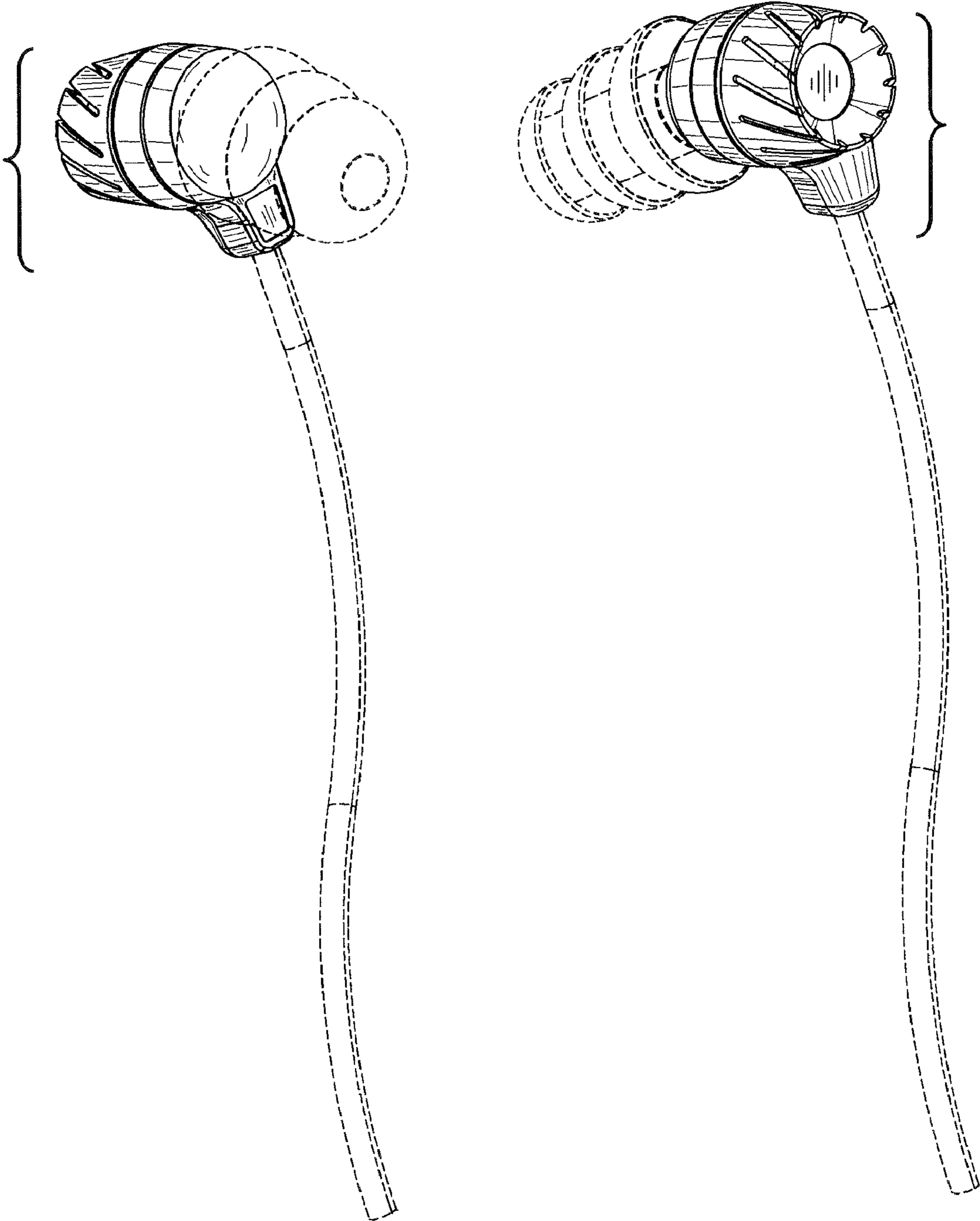


Figure 8



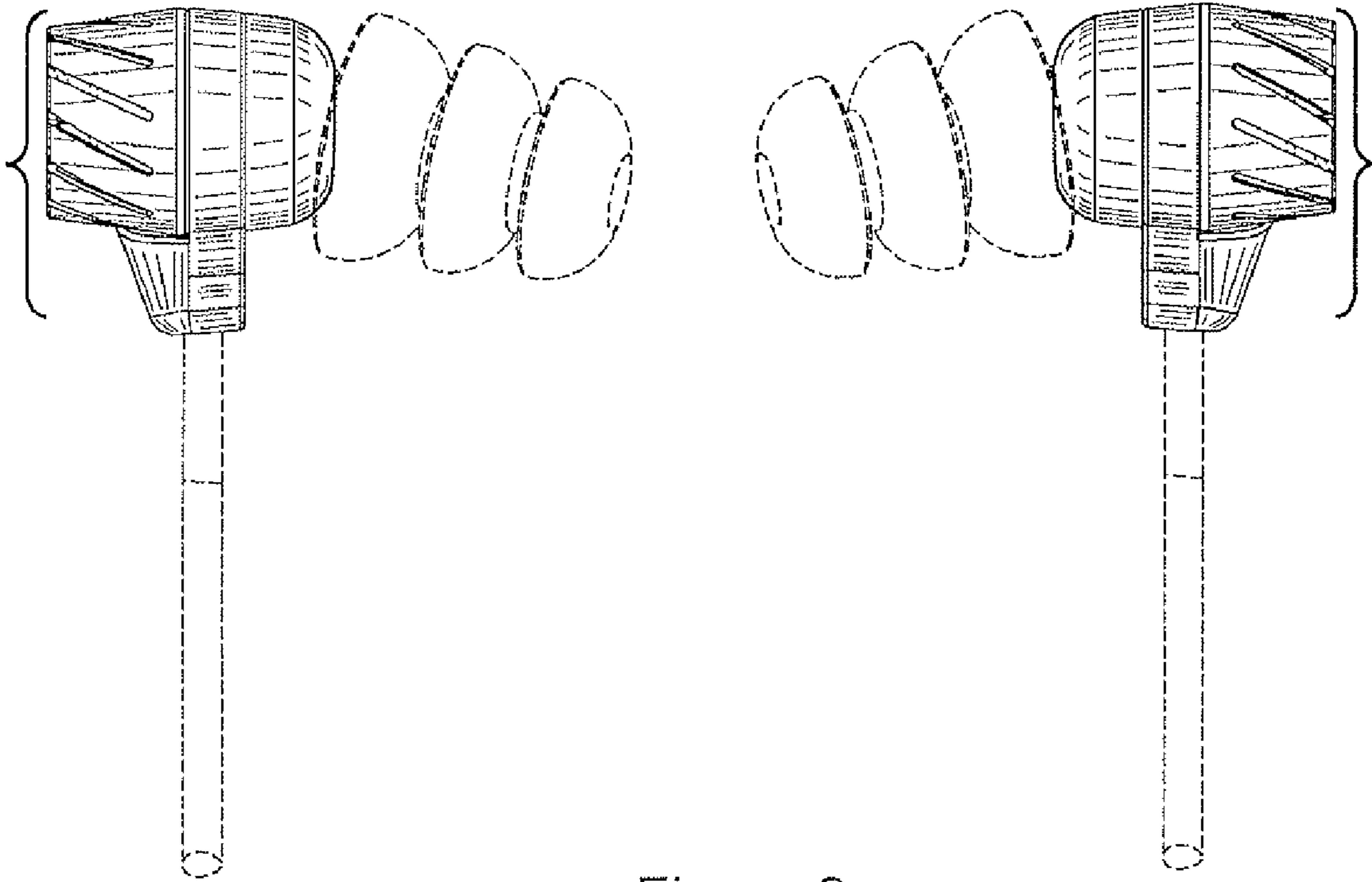


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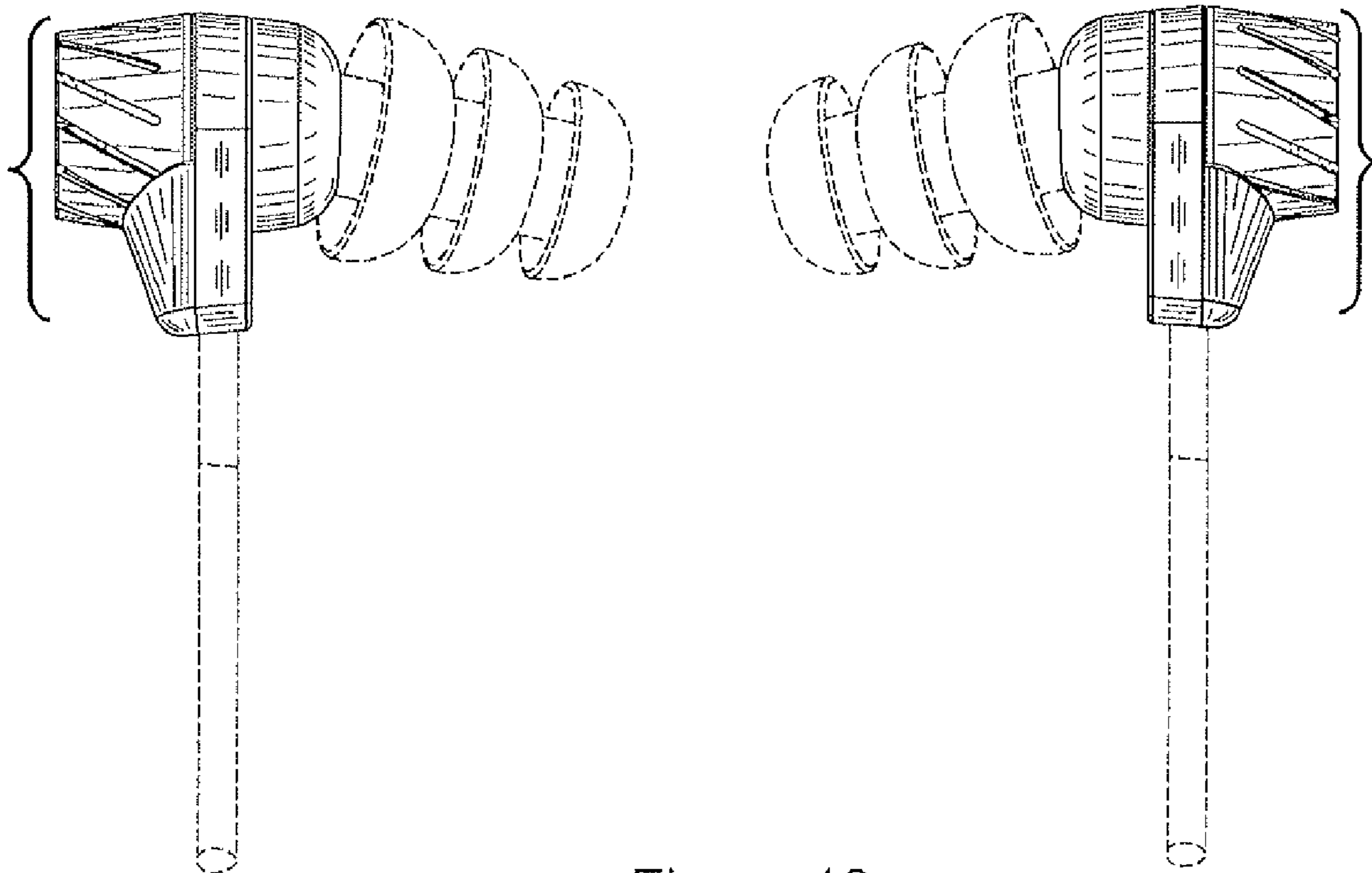


Figure 10

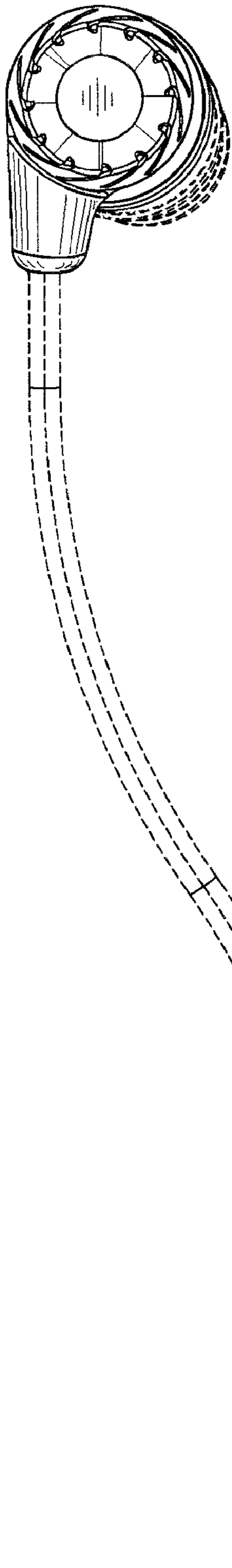


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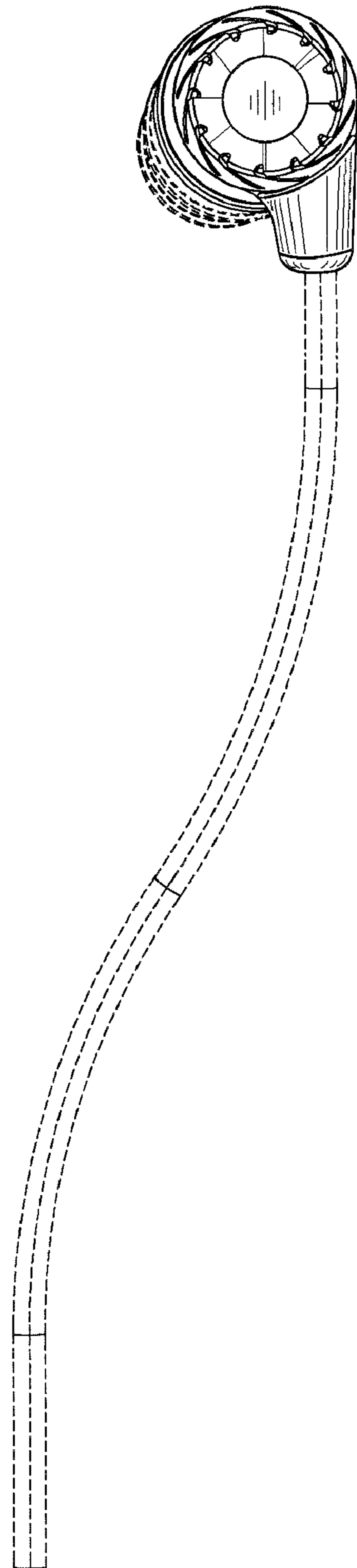


Figure 12

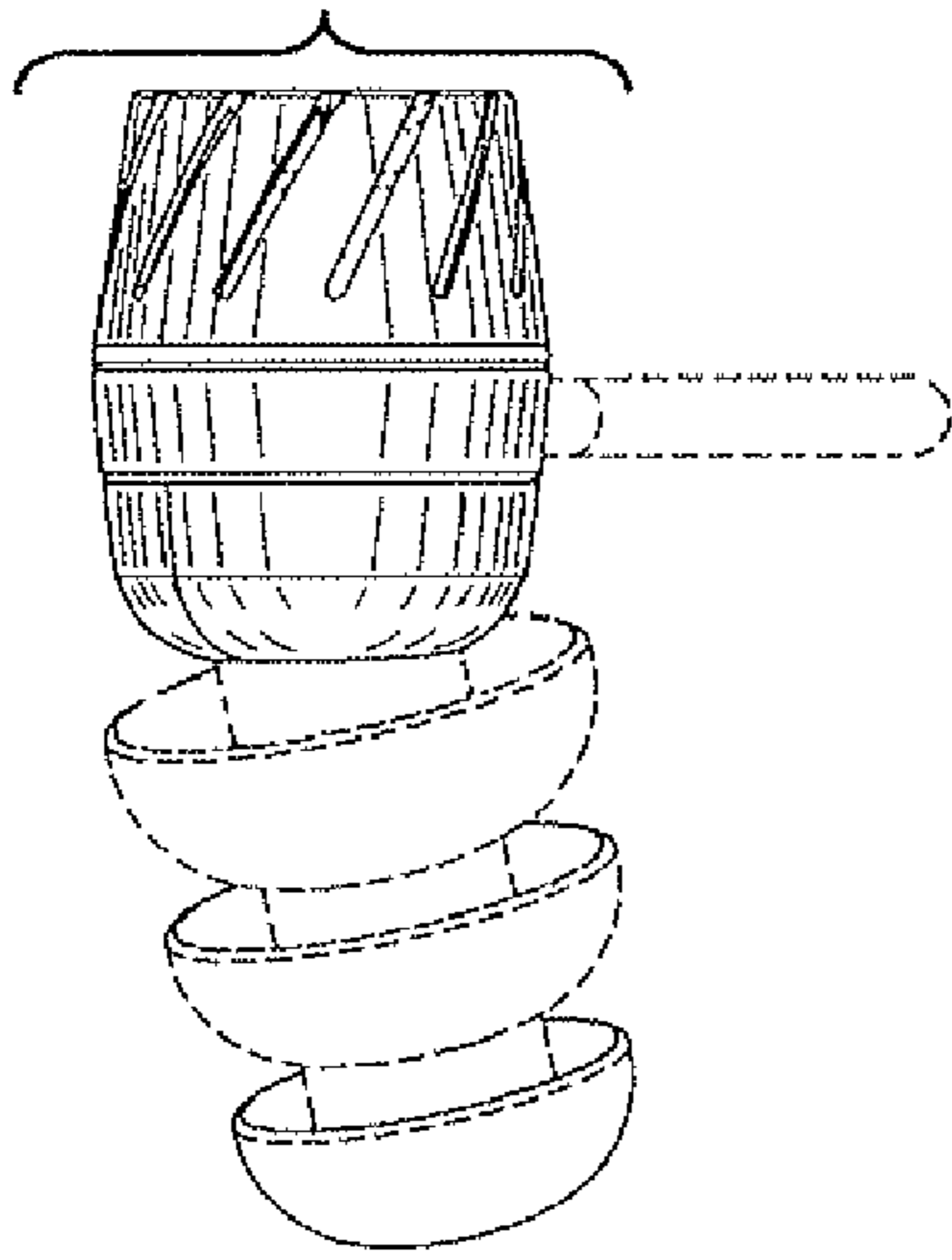


Figure 13

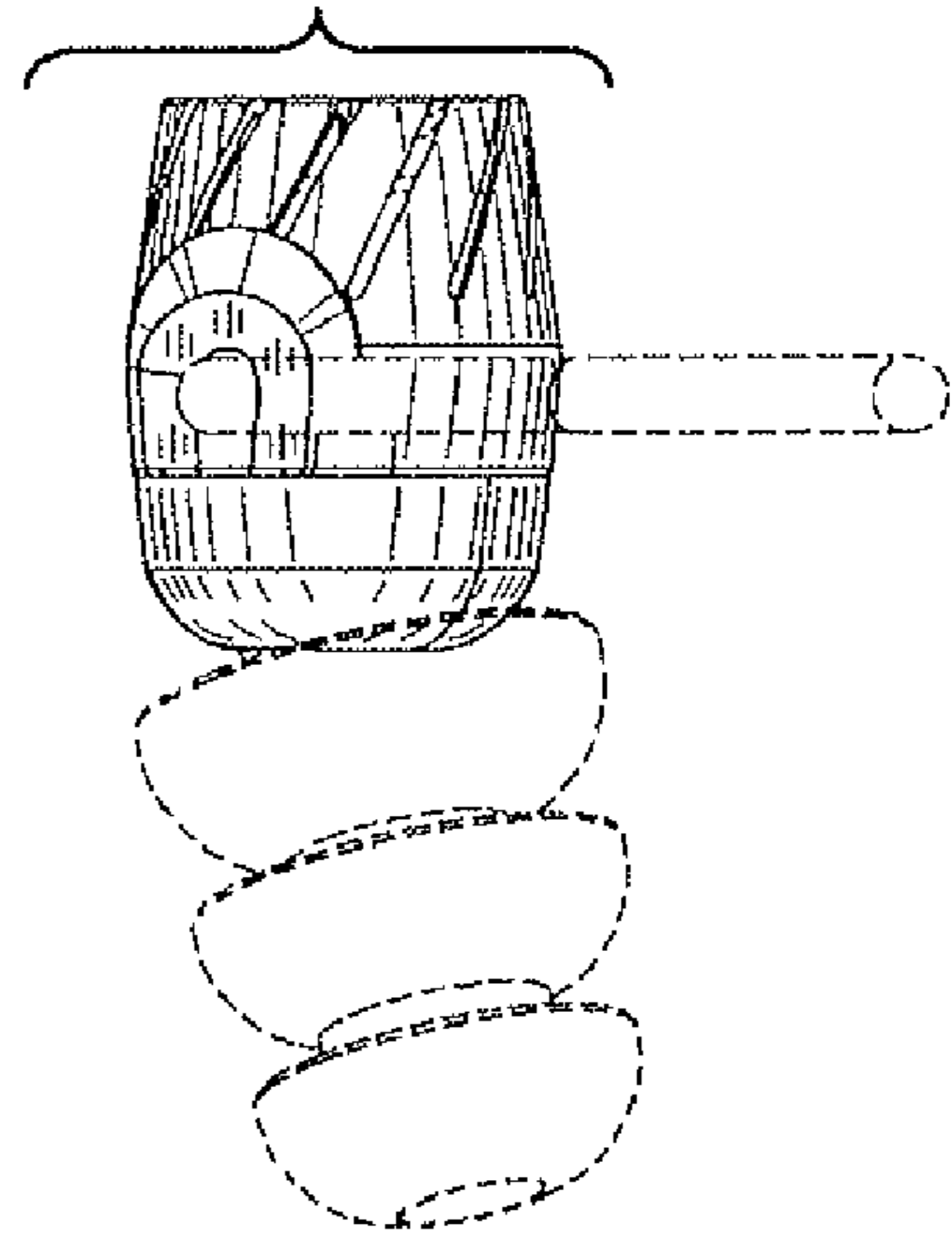


Figure 14

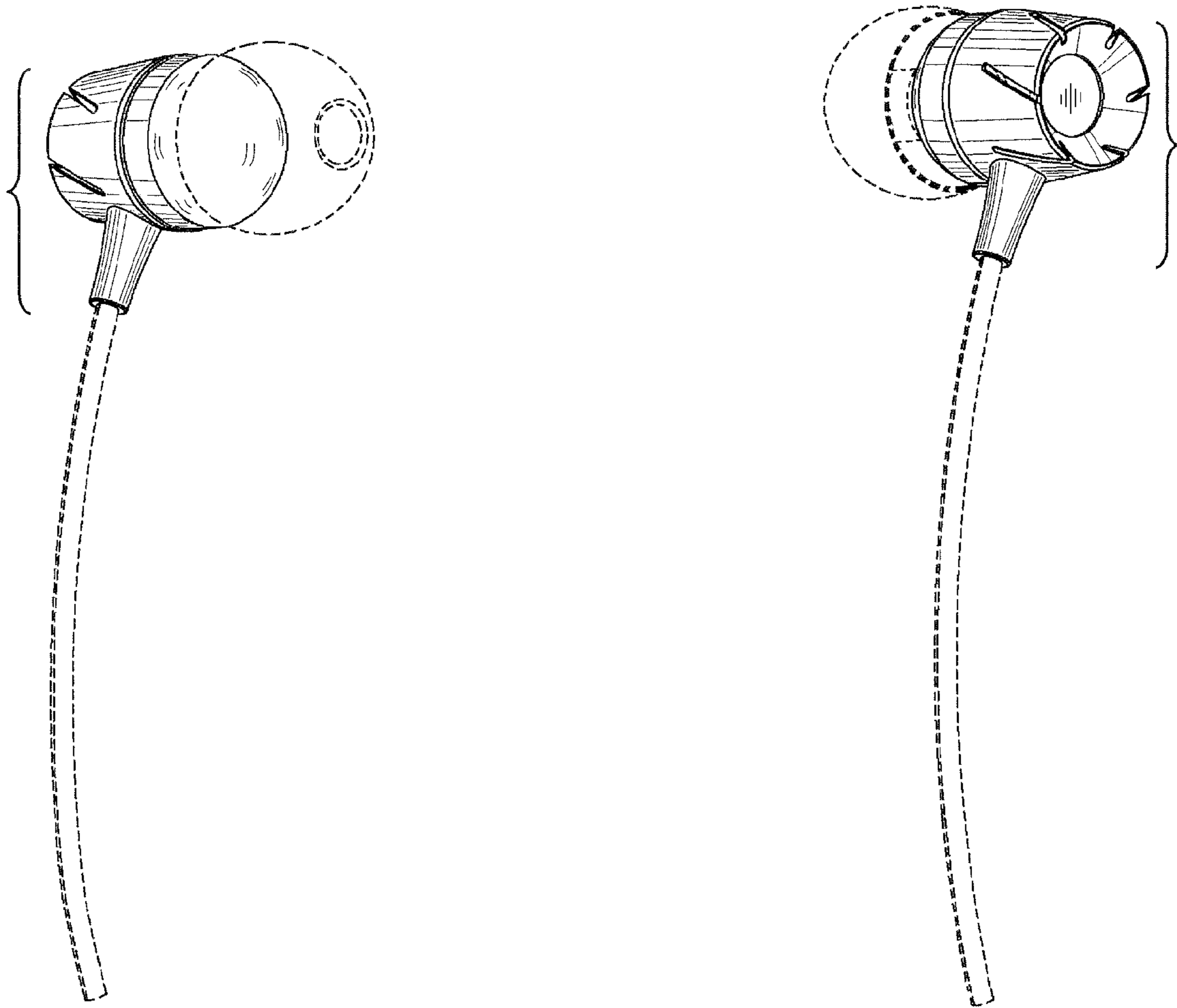


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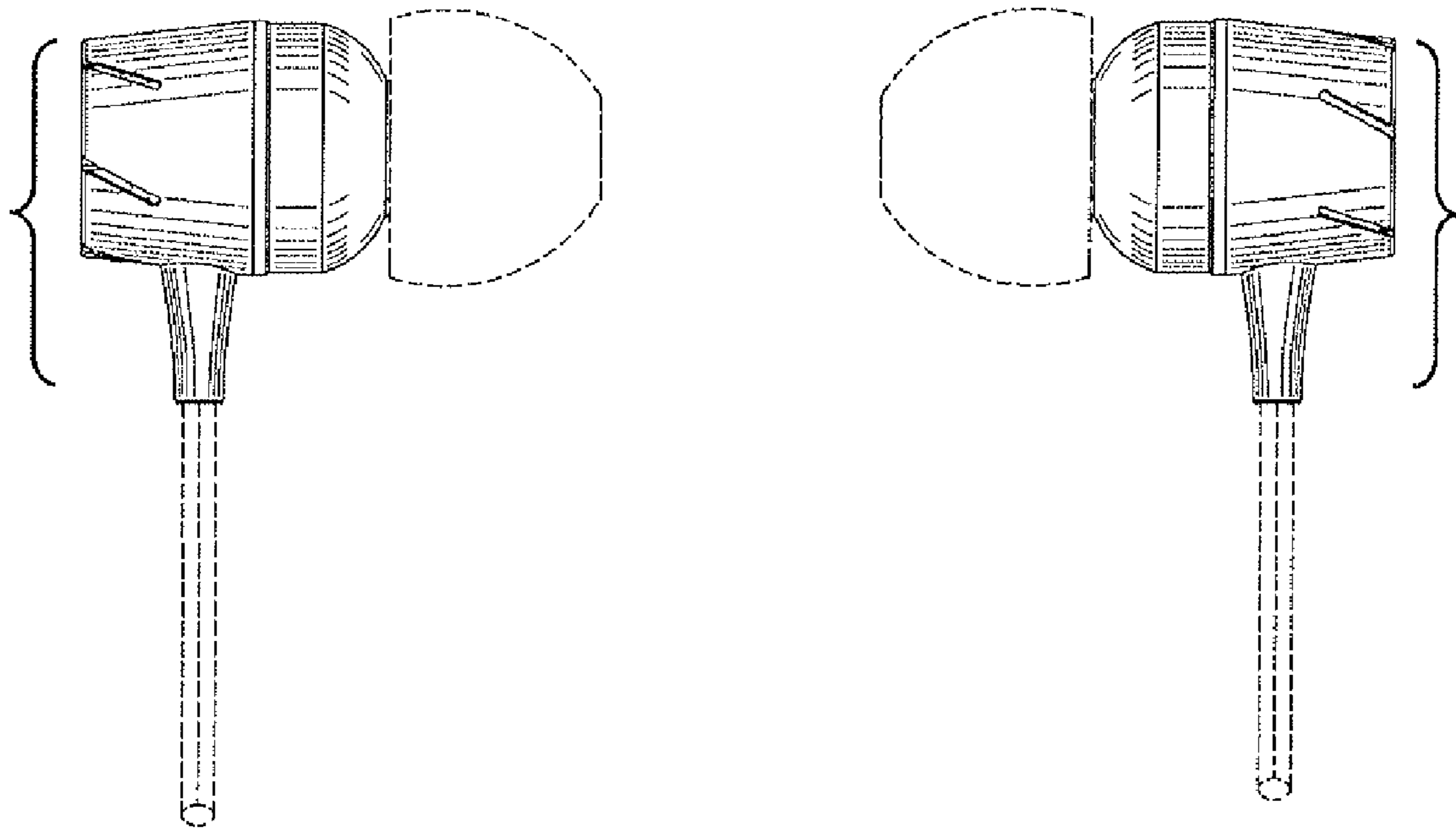


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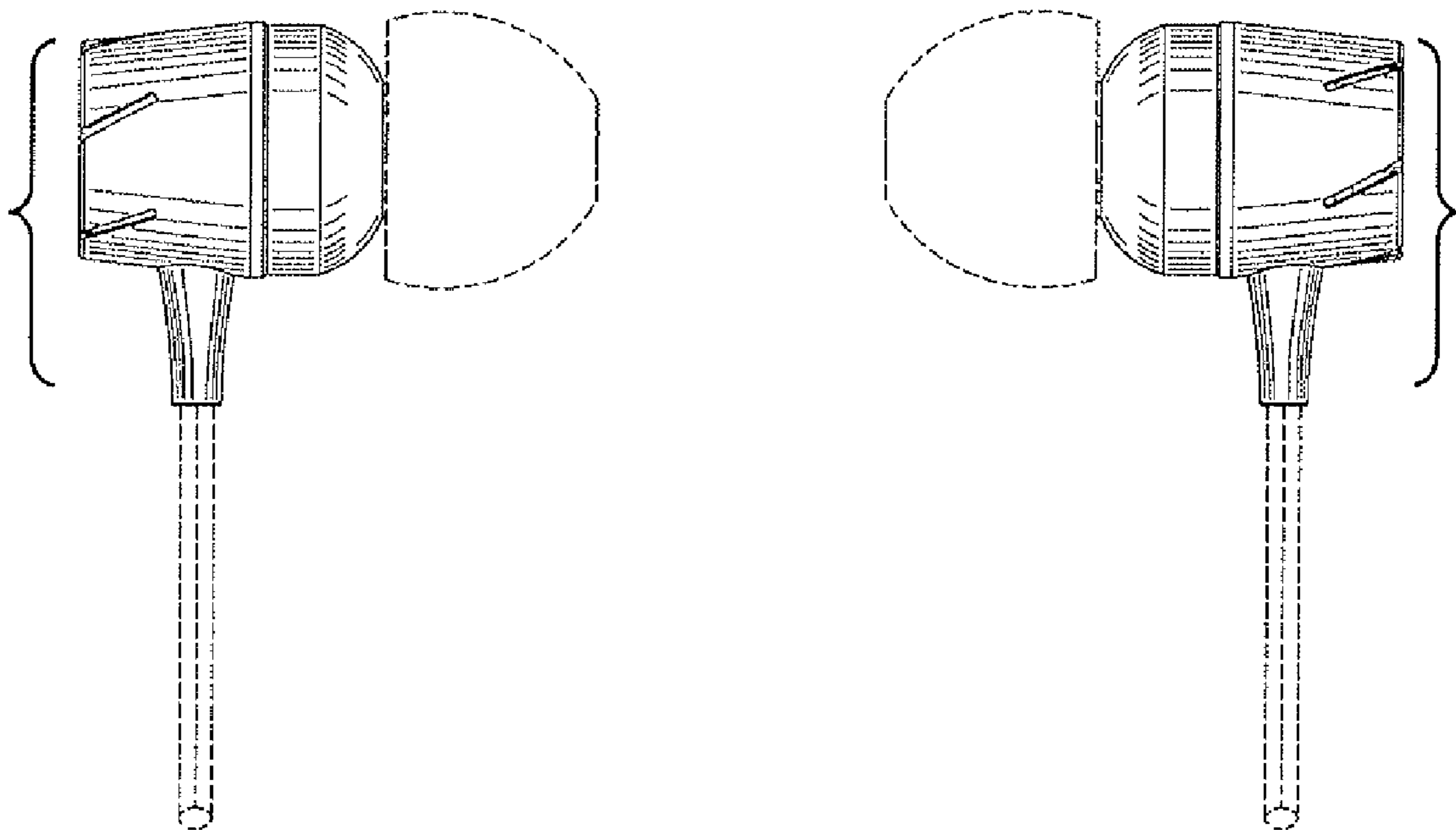


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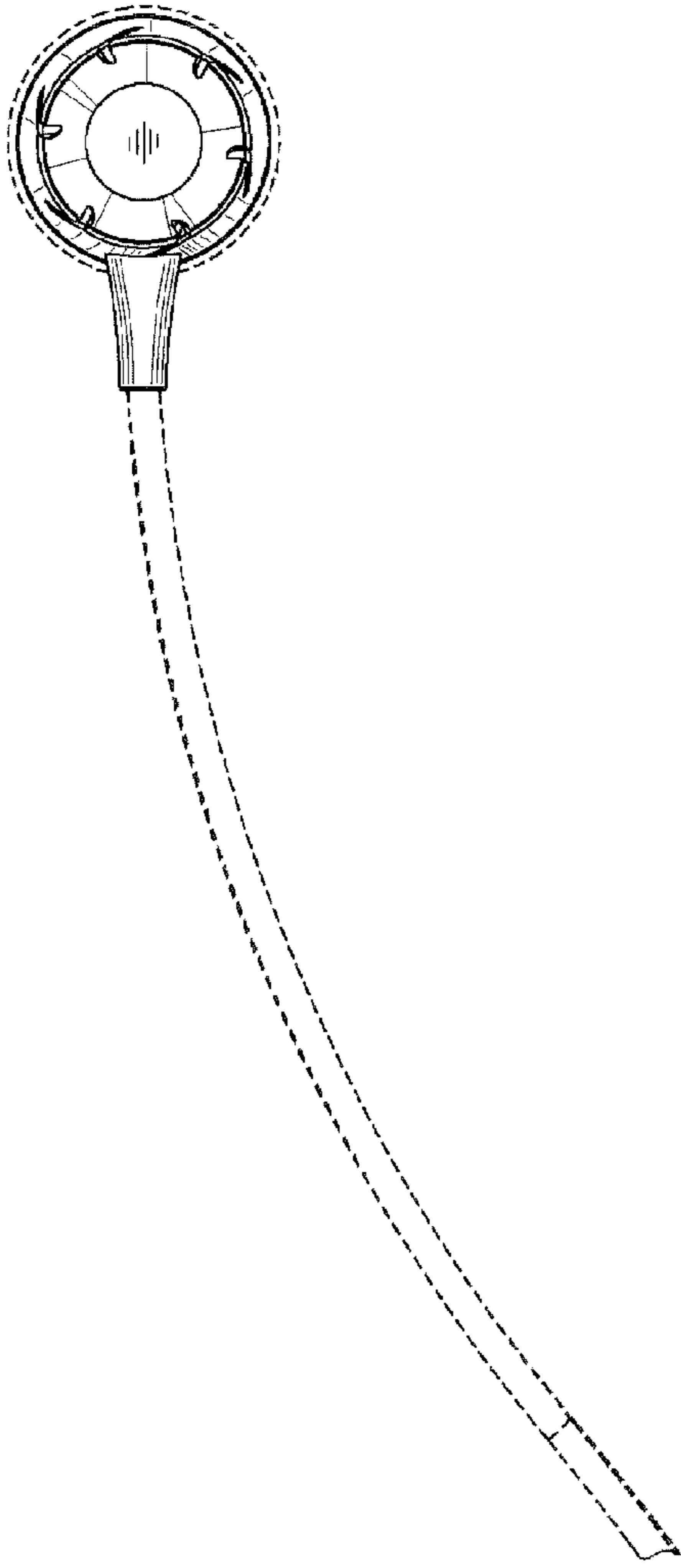


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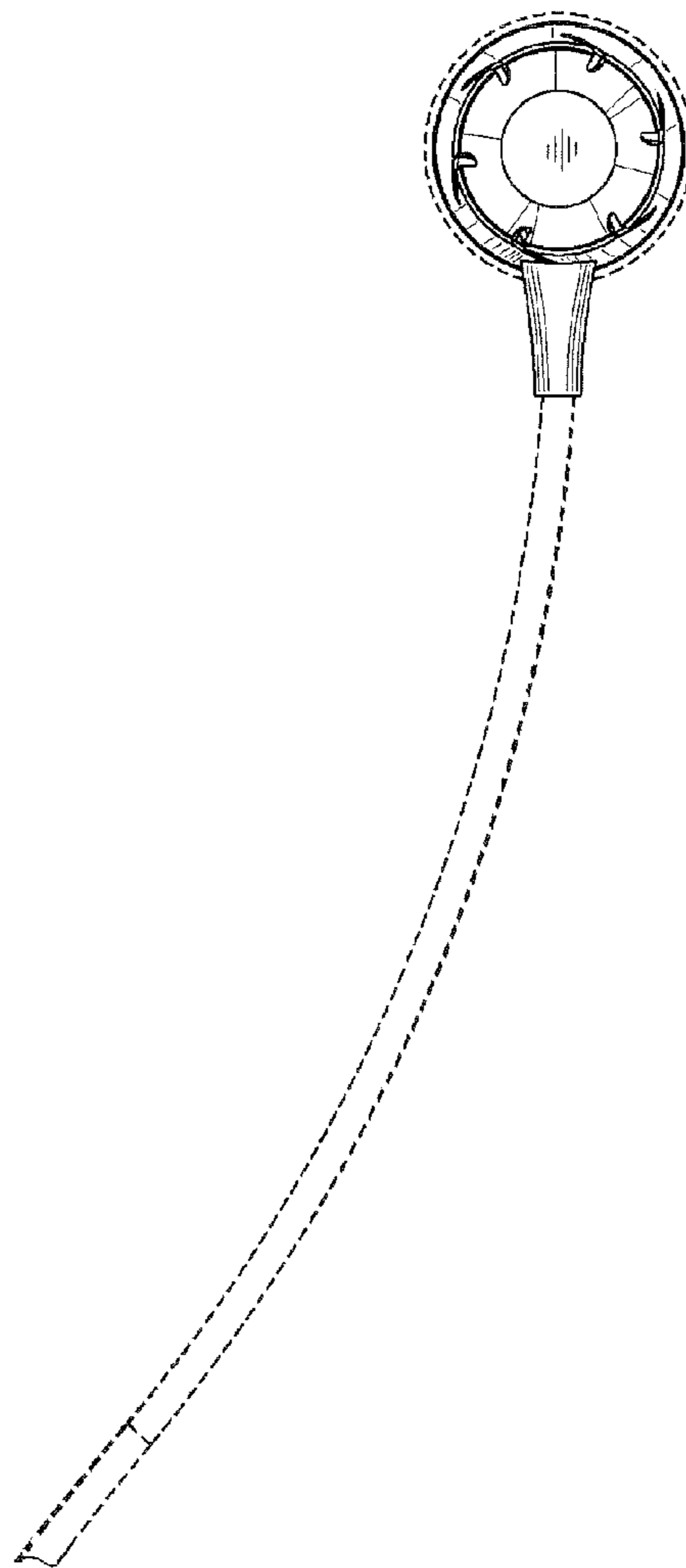


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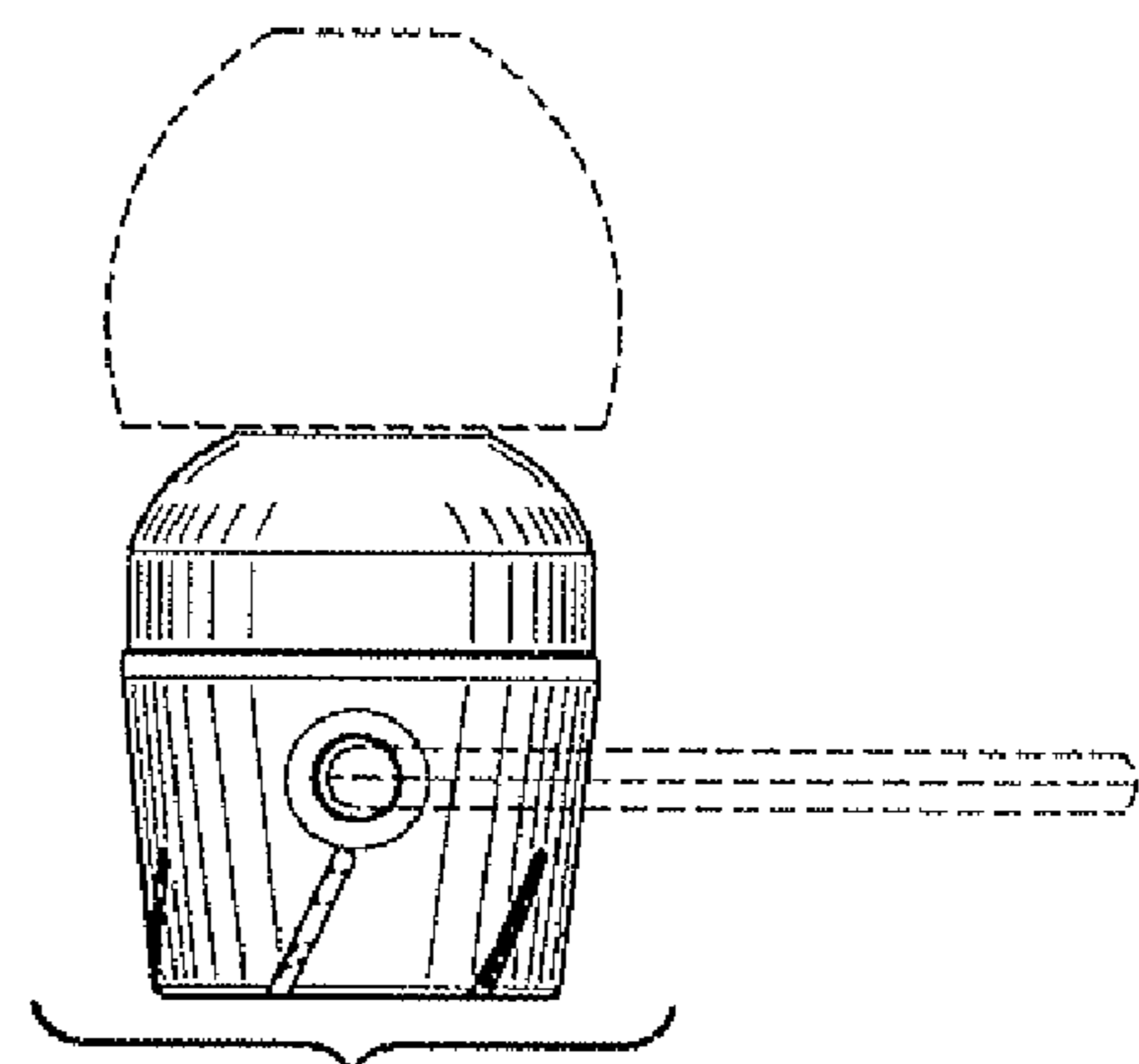
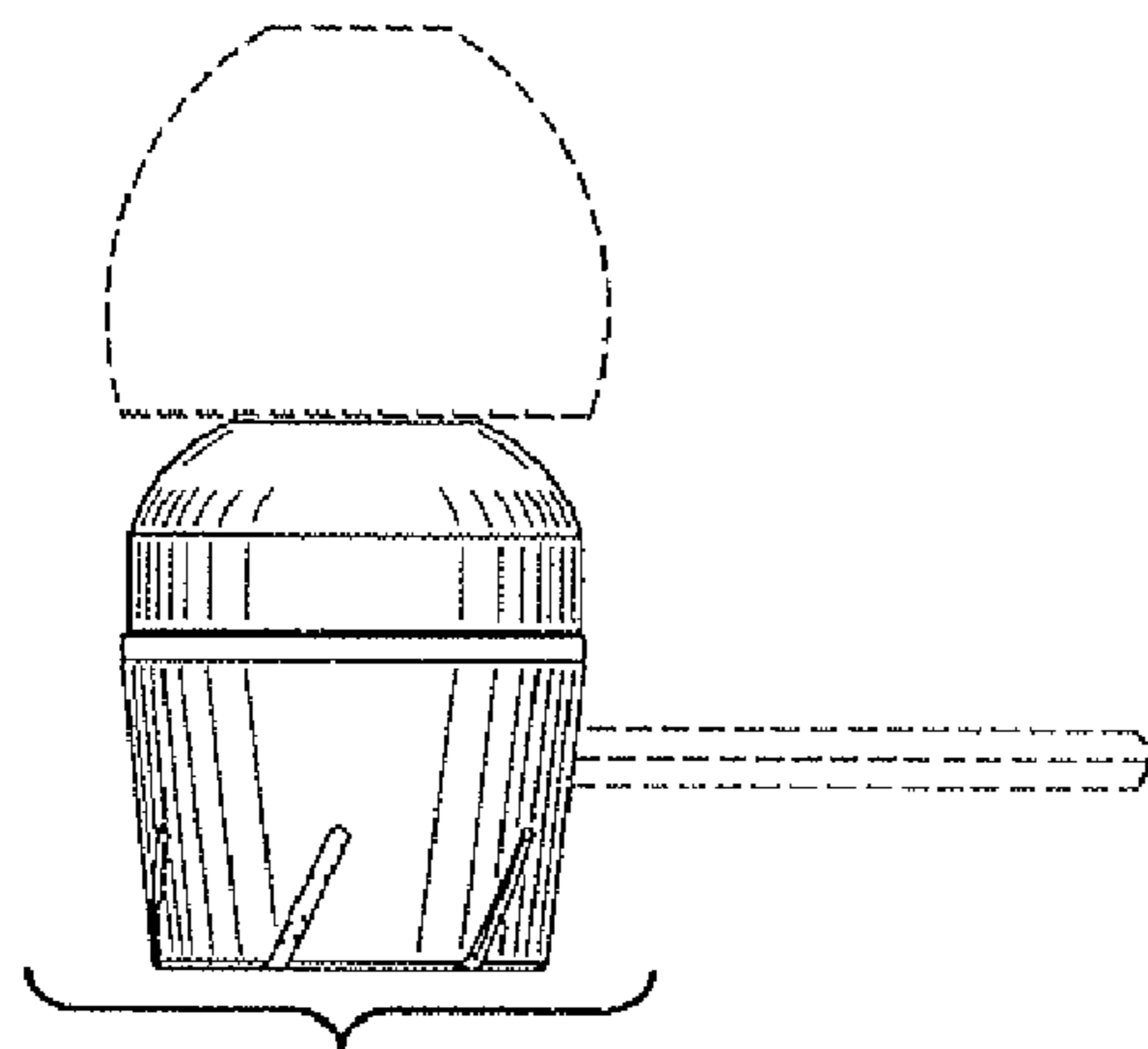
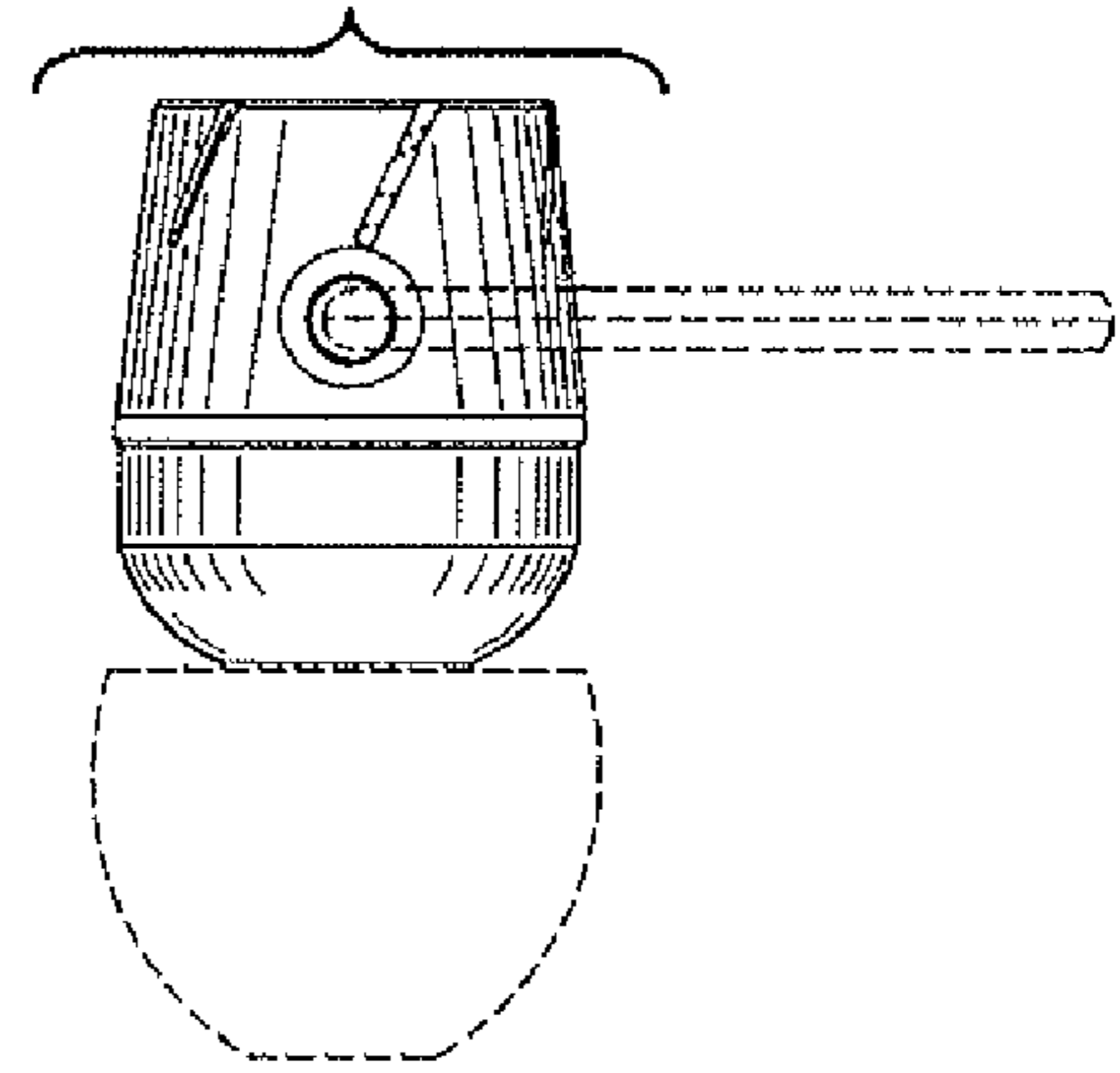
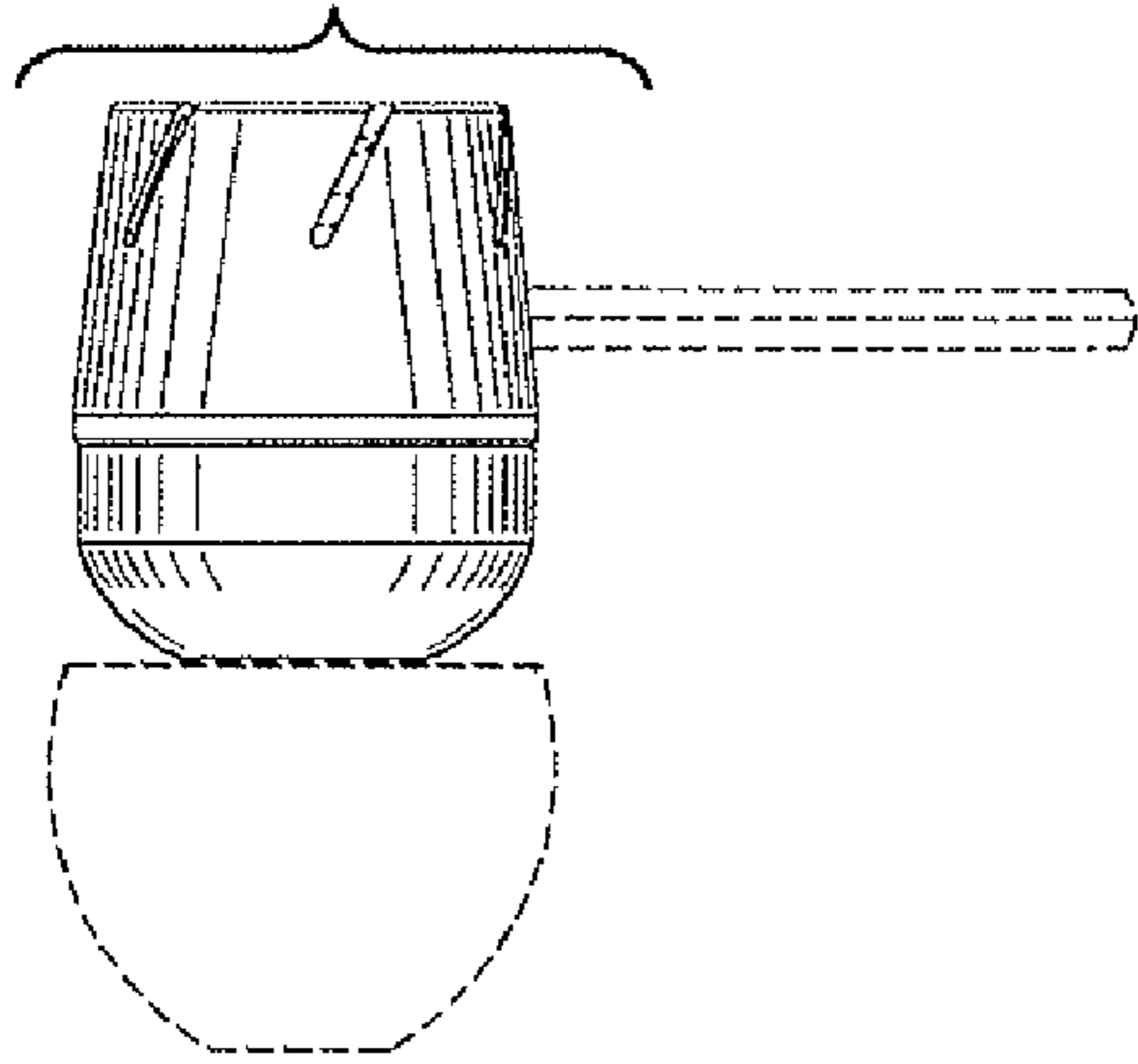


Figure 20

Figure 21